

## 2N4402



# **PNP General Purpose Amplifier**

This device is designed for use as general purpose amplifiers and switches requiring collector currents to 500 mA.

#### **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	40	V
V <sub>CBO</sub>	Collector-Base Voltage	40	V
$V_{EBO}$	Emitter-Base Voltage 5.0 V		V
Ic	Collector Current - Continuous	600	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		2N4402	
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5.0	mW mW/°C
R <sub>eJC</sub>	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

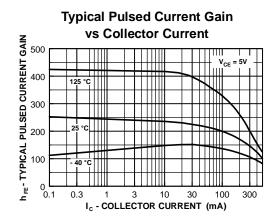
# PNP General Purpose Amplifier (continued)

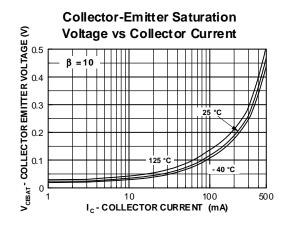
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	40		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100 \mu\text{A}, I_E = 0$	40		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 100  \mu A, I_C = 0$	5.0		V
I <sub>CEX</sub>	Collector Cutoff Current	$V_{CE} = 35 \text{ V}, V_{EB} = 0.4 \text{ V}$		0.1	μΑ
I <sub>BL</sub>	Base Cutoff Current	$V_{CE} = 35 \text{ V}, V_{EB} = 0.4 \text{ V}$		0.1	μΑ
ON CHAF	RACTERISTICS*				
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 1.0 \text{ V}, I_{C} = 1.0 \text{ mA}$	30		
		$V_{CE} = 1.0 \text{ V}, I_{C} = 10 \text{ mA}$	50		
		$V_{CE} = 2.0 \text{ V}, I_{C} = 150 \text{ mA}$	50 20	150	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$V_{CE} = 2.0 \text{ V}, I_{C} = 500 \text{ mA}$ $I_{C} = 150 \text{ mA}, I_{B} = 15 \text{ mA}$	20	0.40	V
VCE(sat)	Collector-Entitler Saturation Voltage	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.40	V
	Dana Fasittan Oatsmatian Valtana				
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	0.75	0.95	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$	0.75	0.95 1.30	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	, -	0.75		
	Base-Emitter Saturation Voltage	, -	0.75		
SMALL S		, -	0.75		
SMALL S	IGNAL CHARACTERISTICS	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA	0.75	1.30	V
SMALL S C <sub>ob</sub> C <sub>ib</sub>	SIGNAL CHARACTERISTICS Output Capacitance	$\begin{split} I_{C} &= 500 \text{ mA}, I_{B} = 50 \text{ mA} \\ \\ V_{CB} &= 10 \text{ V}, f = 140 \text{ kHz} \\ \\ V_{EB} &= 0.5 \text{ V}, f = 140 \text{ kHz} \\ \\ I_{C} &= 20 \text{ mA}, V_{CE} = 10 \text{ V}, \end{split}$	1.5	1.30	pF
SMALL S C <sub>ob</sub> C <sub>ib</sub>	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance	$I_C$ = 500 mA, $I_B$ = 50 mA $V_{CB}$ = 10 V, f = 140 kHz $V_{EB}$ = 0.5 V, f = 140 kHz		1.30	pF
SMALL S	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain	$I_C$ = 500 mA, $I_B$ = 50 mA $V_{CB}$ = 10 V, f = 140 kHz $V_{EB}$ = 0.5 V, f = 140 kHz $I_C$ = 20 mA, $V_{CE}$ = 10 V, f = 100 MHz	1.5	8.5 30	v V
SMALL S C <sub>ob</sub> C <sub>ib</sub> n <sub>fe</sub>	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain	$\begin{split} &I_C = 500 \text{ mA}, I_B = 50 \text{ mA} \\ &V_{CB} = 10 \text{ V}, f = 140 \text{ kHz} \\ &V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz} \\ &I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, \\ &f = 100 \text{ MHz} \\ &I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, \end{split}$	1.5	8.5 30 250	pF pF
SMALL S Cob Cib hfe hfe hie hre	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance	$\begin{split} &I_C = 500 \text{ mA}, I_B = 50 \text{ mA} \\ &V_{CB} = 10 \text{ V}, f = 140 \text{ kHz} \\ &V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz} \\ &I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, \\ &f = 100 \text{ MHz} \\ &I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, \end{split}$	1.5 30 0.75	1.30 8.5 30 250 7.5	PF PF kΩ x10 <sup>-4</sup>
SMALL S Cob Cib hfe hie hre hoe	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio	$\begin{split} &I_C = 500 \text{ mA}, I_B = 50 \text{ mA} \\ &V_{CB} = 10 \text{ V}, f = 140 \text{ kHz} \\ &V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz} \\ &I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, \\ &f = 100 \text{ MHz} \\ &I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, \end{split}$	1.5 30 0.75 0.10	1.30 8.5 30 250 7.5 8.0	PF PF KΩ
SMALL S Cob Cib hfe hfe hie hre hoe	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio	$\begin{split} &I_C = 500 \text{ mA}, I_B = 50 \text{ mA} \\ &V_{CB} = 10 \text{ V}, f = 140 \text{ kHz} \\ &V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz} \\ &I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, \\ &f = 100 \text{ MHz} \\ &I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, \end{split}$	1.5 30 0.75 0.10	1.30 8.5 30 250 7.5 8.0	PF PF kΩ x10 <sup>-4</sup>
SMALL S Cob Cib hfe hfe hie hre hoe	Output Capacitance Input Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio Output Admittance	$\begin{split} &I_C = 500 \text{ mA}, I_B = 50 \text{ mA} \\ &V_{CB} = 10 \text{ V}, f = 140 \text{ kHz} \\ &V_{EB} = 0.5 \text{ V}, f = 140 \text{ kHz} \\ &I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, \\ &f = 100 \text{ MHz} \\ &I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, \end{split}$	1.5 30 0.75 0.10	1.30 8.5 30 250 7.5 8.0	PF PF kΩ x10 <sup>-4</sup>
SMALL S Cob Cib hfe hie hoe	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio Output Admittance  NG CHARACTERISTICS	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ V_{CB} &= 10 \text{ V}, \ f = 140 \text{ kHz} \\ \\ V_{EB} &= 0.5 \text{ V}, \ f = 140 \text{ kHz} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ \\ V_{CC} &= 30 \text{ V}, \ I_C = 150 \text{ mA}, \end{split}$	1.5 30 0.75 0.10	1.30 8.5 30 250 7.5 8.0 100	PF pF kΩ x10 <sup>-4</sup> μmhos
SMALL S Cob Cib hfe hie hre hoe	SIGNAL CHARACTERISTICS Output Capacitance Input Capacitance Small-Signal Current Gain Small-Signal Current Gain Input Impedance Voltage Feedback Ratio Output Admittance  NG CHARACTERISTICS Delay Time	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ V_{CB} &= 10 \text{ V}, \ f = 140 \text{ kHz} \\ \\ V_{EB} &= 0.5 \text{ V}, \ f = 140 \text{ kHz} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \end{split}$	1.5 30 0.75 0.10	1.30 8.5 30 250 7.5 8.0 100	PF pF kΩ x10 <sup>-4</sup> μmhos

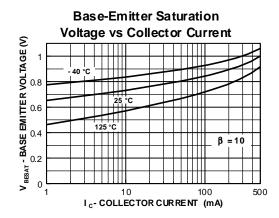
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

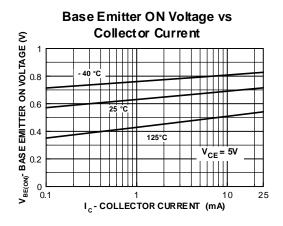
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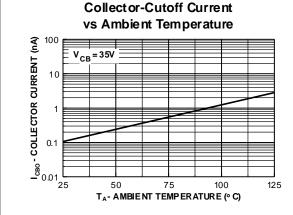
#### **Typical Characteristics**

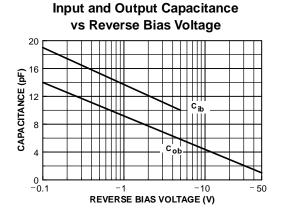






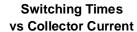


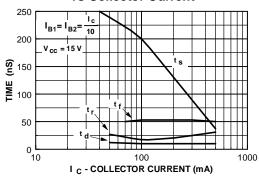




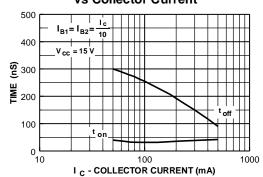
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### Typical Characteristics (continued)

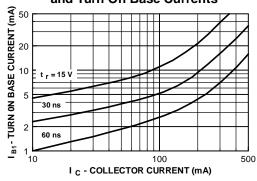




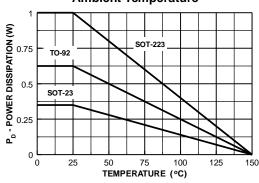
# Turn On and Turn Off Times vs Collector Current



# Rise Time vs Collector and Turn On Base Currents

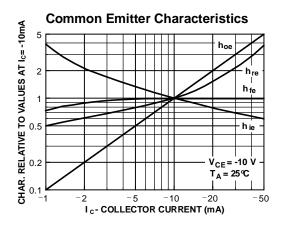


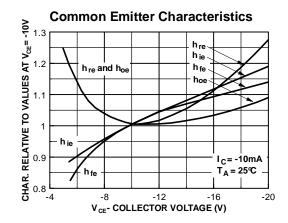
#### Power Dissipation vs Ambient Temperature

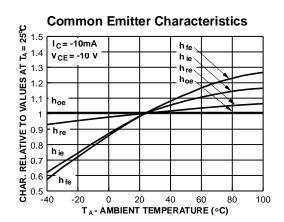


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#### **Typical Common Emitter Characteristics** (f = 1.0kHz)







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#### **Test Circuits**

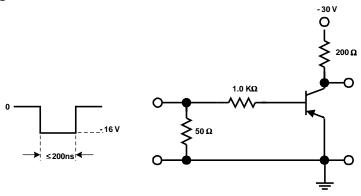


FIGURE 1: Saturated Turn-On Switching Time Test Circuit

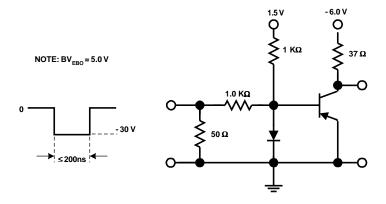


FIGURE 2: Saturated Turn-Off Switching Time Test Circuit

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